





#### Description

- ➤ 4.5x4.5x32mm physical size
- 1000VDC High voltage ,High Breaking Capacity

#### **Electrical Characteristics**

| % rated current | Opening Time       |  |
|-----------------|--------------------|--|
| 100%            | 4hours, Minimum    |  |
| 250%            | % 120sec., Maximum |  |

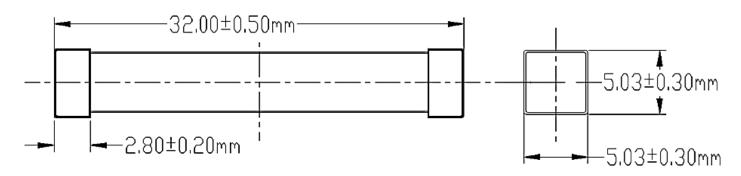


#### **Specifications**

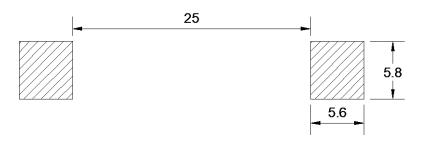
| Part No.    | Rated Voltage | Rated Current | Breaking<br>Capacity<br>(KA) <sup>1</sup> | Typical Cold.<br>Resistance<br>(mohms) <sup>2</sup> | Typical<br>Voltage<br>Drop<br>(mV) | Typical Pre-<br>Arcing I <sup>2</sup> t<br>(A <sup>2</sup> S) <sup>3</sup> |
|-------------|---------------|---------------|---|---|------------------------------------|--|
| A324501.0.8 | 1000Vdc       | 800mA         | 10KA@1000Vdc                              | 560   | 500                                | 0.65   |
| A324501.1   |               | 1A            |   | 435   | 480                                | 1.30   |
| A324501.2   |               | 2A            |   | 140   | 415                                | 1.5  |
| A324501.2.5 |               | 2.5A          |   | 106   | 385                                | 2.5  |
| A324501.3   |               | 3A            |   | 90  | 390                                | 4.0  |

- 1. DC Interrupting Rating (measured at designated voltage, time constant of less than 50 microseconds)
- 2. DC Cold Resistance are measured at <10% of rated current in ambient temperature of 25°C
- 3. Typical Pre-arcing I<sup>2</sup>t are measured at 10ln Current, DC battery bank.

### Dimensions (unit: mm)



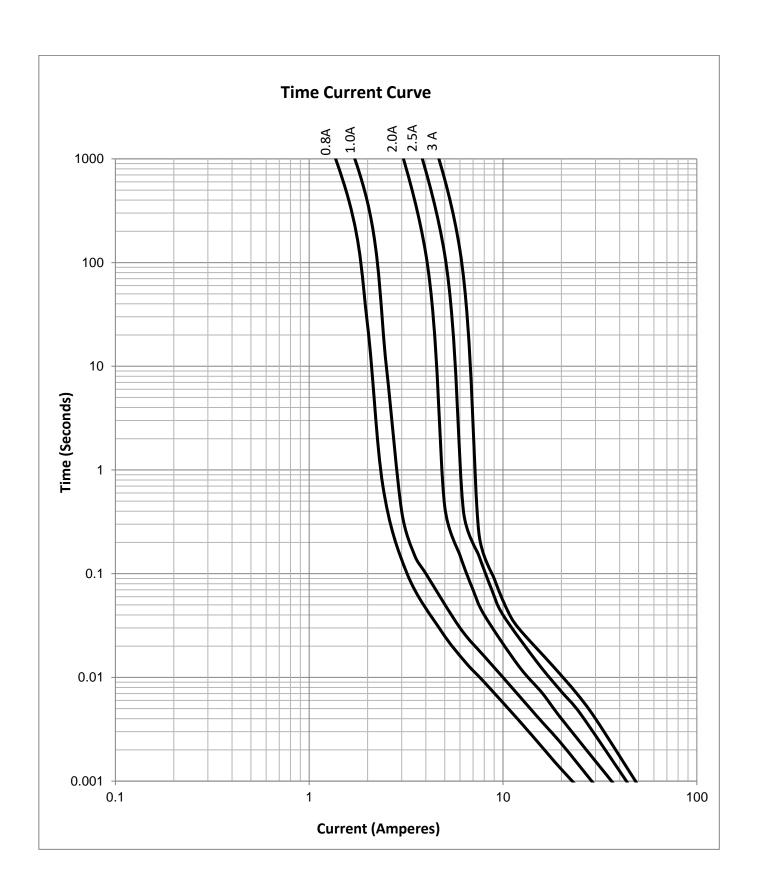
### Recommended Pad Layout (unit: mm)



Note: above land pattern recommended for reflow soldering; for hand soldering, consider to make a larger pad.













### **Soldering Characteristics**

Reflow Soldering

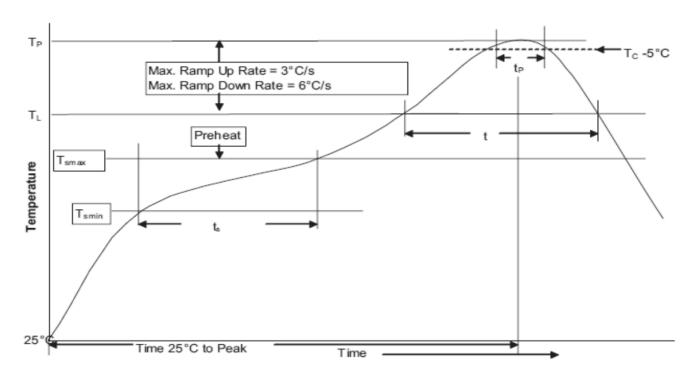
• Temperature: 260° C

• Time: 30 Seconds Maximum

Manual Soldering (not recommended)

• Temperature: 350° C

• Time: 5 Seconds Maximum



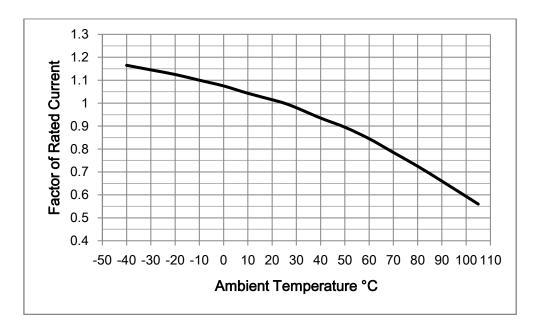
| Profile Feature                               |   | Lead(Pb) free solder |
|---|---|----------------------|
| Preheat and soak                              | <ul> <li>Temperature min.(T<sub>smin</sub>)</li> </ul>                          | 150℃                 |
|   | Temperature max. (T <sub>smax</sub> )   | 200℃                 |
|   | <ul> <li>Time (T<sub>smin</sub> to T<sub>smax</sub>) (t<sub>s</sub>)</li> </ul> | 60 - 120 Seconds     |
| Average ramp up rate T <sub>smax</sub> to     | 3℃ / Second Max.  |                      |
| Liquidous temperature (T <sub>L</sub> )       | 217℃  |                      |
| Time at liquidous (t∟)                        | 60 - 150 Seconds  |                      |
| Peak package body temperatu                   | <b>260</b> ℃  |                      |
| Time (t <sub>P</sub> ) within 5°C of the spec | 30 Seconds  |                      |
| (T <sub>C</sub> )                             |   |                      |
| Average ramp-down rate (TP to                 | 6℃ / Second Max.  |                      |
| Time (25℃ to Peak Temperatu                   | 8 Minutes Max.  |                      |





### **Temperature Re-rating curve**

- Normal Operating Temperature: 25 ℃
- Operating Temperature: -40°C to 105°C with proper correction factor applied.



### **Package and Minimum order QTY**

1000pcs fuses in tape (width 44mm) and reel (dia. 13inch)